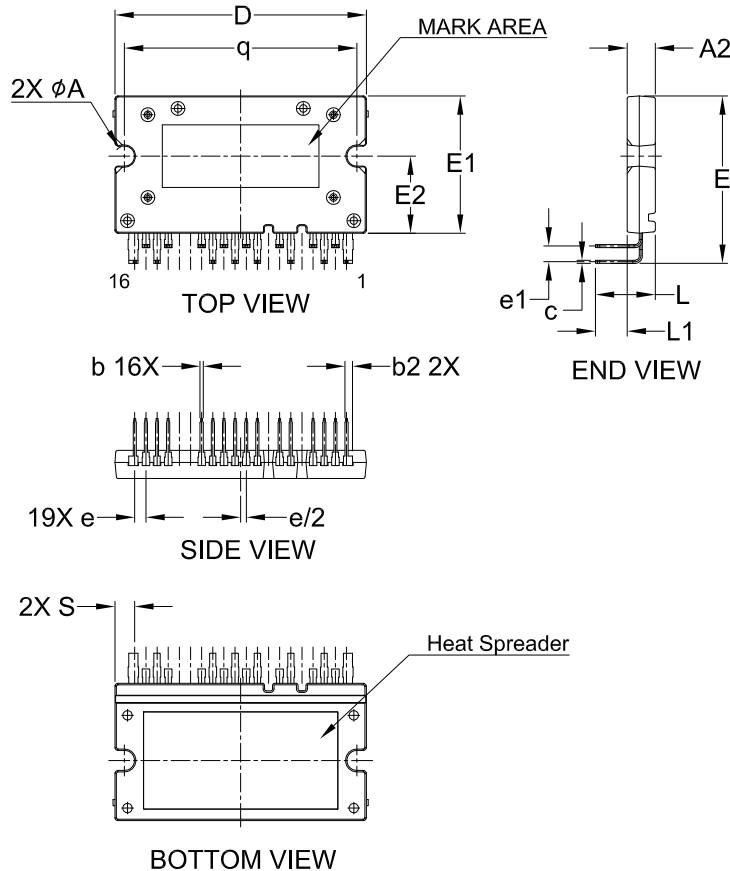


PIM16 40.10x21.90x4.50  
CASE MODGJ  
ISSUE D

DATE 17 JAN 2024



NOTES:

1. DIMENSIONING AND TOLERANCING PER. ASME Y14.5M, 2009.
2. CONTROLLING DIMENSION: MILLIMETERS
3. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH AND TIE BAR EXTRUSIONS.

DIM	MILLIMETERS		
	MIN.	NOM.	MAX.
A2	4.30	4.50	4.70
b	0.45	0.50	0.60
b2	1.15	1.20	1.30
c	0.45	0.50	0.60
D	39.90	40.10	40.30
E	26.20	26.70	27.20
E1	21.70	21.90	22.10
E2	12.10	12.30	12.50
e	1.478	1.778	2.078
e1	2.20	2.50	2.80
L	9.20	9.55	9.90
L1	5.05 REF		
q	36.85	37.10	37.35
S	3.159 REF		
φA	3.00	3.20	3.40

GENERIC  
MARKING DIAGRAM\*

XXXXXXXXXXXXXXXXXX  
ZZZ ATYWW  
NNNNNNN

XXXX = Specific Device Code  
ZZZ = Lot ID  
AT = Assembly & Test Location  
Y = Year  
W = Work Week  
NNN = Serial Number

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

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DESCRIPTION:	PIM16 40.10x21.90x4.50	PAGE 1 OF 1

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